9**∏** 3B

- Meet or Exceed the EIA Standards
 RS-422-A, RS-423-A, RS-485, and CCITT
 Recommendation V.11
- Designed to Operate With Pulse Durations as Short as 20 ns
- Designed for Multipoint Transmission on Long Bus Lines in Noisy Environments
- Input Sensitivity . . . ±200 mV
- Low-Power Consumption . . . 20 mA Max
- Open-Circuit Fail-Safe Design
- Common-Mode Input Voltage Range of -7 V to 12 V
- Pin Compatible With SN75175 and MC3486

description

The SN65LBC175 and SN75LBC175 monolithic, quadruple, differential line receivers with 3-state outputs and are designed to meet the requirements of the EIA standards RS-422-A, RS-423-A, RS-485, and CCITT Recommendation V.11. The devices are optimized for balanced multipoint bus transmission at data rates up to and exceeding 10 million bits per second. The receivers are enabled in pairs, with an active-high enable input. Each differential receiver input features high impedance, hysteresis increased noise immunity, and sensitivity of ±200 mV over a common-mode input voltage range of 12 V to -7 V. The fail-safe design ensures that when the inputs are open-circuited, the outputs are always high. Both devices are designed using the TI proprietary LinBiCMOS™ technology allowing low power consumption, high switching speeds, and robustness.

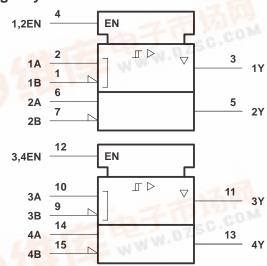
These devices offer optimum performance when used with the SN75LBC172 or SN75LBC174 quadruple line drivers. The SN65LBC175 and SN75LBC175 are available in the 16-pin DIP (N) and small-outline inline circuit (SOIC) D packages.

The SN65LBC175 is characterized over the industrial temperature range of -40°C to 85°C. The SN75LBC175 is characterized for operation over the commercial temperature range of 0°C to 70°C.

(TOP VIEW) 16 VCC 1B [15 4B 1A 1Y [3 14 A 13 **1** 4Y 1.2EN 12 3,4EN 2Y 11 3Y 2A 🛮 6 10 1 3A

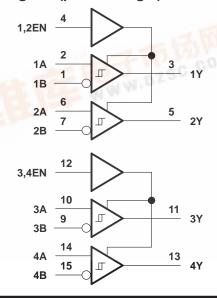
D OR N PACKAGE

2B [] GND [] logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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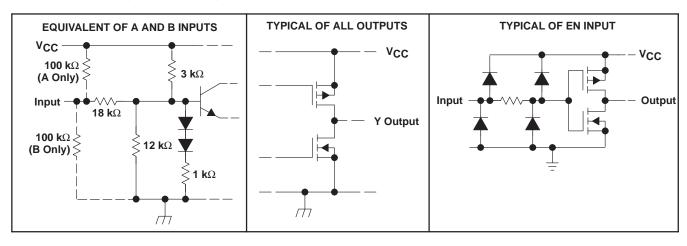
FUNCTION TABLE (each receiver)

DIFFERENTIAL INPUTS A-B	ENABLE	OUTPUT Y
V _{ID} ≥ 0.2 V	Н	Н
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$	Н	?
$V_{ID} \le -0.2 V$	Н	L
X	L	Z
Open circuit	Н	Н

 $H = high \ level, \quad \ L = low \ level, \quad \ X = irrelevant,$

Z = high impedance (off), ? = indeterminate

schematics of inputs and outputs



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC} (see Note 1)	
Input voltage, V _I (A or B inputs)	±25 V
Differential input voltage, V _{ID} (see Note 2)	±25 V
Voltage range at Y, 1/2EN, 3/4EN	\dots -0.3 V to V _{CC} + 0.5 V
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A : SN65LBC175	–40°C to 85°C
SN75LBC175	0°C to 70°C
Storage temperature range, T _{stq}	65°C to 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to GND.

2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{$\Delta$}} \leq 25^{\circ}\mbox{$C$}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	
D	1100 mW	8.7 mW/°C	709 mW	578 mW	
N	1150 mW	9.2 mW/°C	736 mW	598 mW	

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	4.75 5 5.25		V
Common-mode input voltage, V _{IC}		-7		12	V
Differential input voltage, V _{ID}				±6	V
High-level input voltage, V _{IH}	EN inputs				V
Low-level input voltage, V _{IL}	EN Inputs			0.8	V
High-level output current, IOH				-8	mA
Low-level output current, I _{OL}				16	mA
Operating free-air temperature, T _A	SN65LBC175	-40		85	°C
	SN75LBC175	0		70	

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT	
V _{IT+}	Positive-going input thres	shold voltage	$I_O = -8 \text{ mA}$	$I_O = -8 \text{ mA}$				0.2	V
VIT-	Negative-going input three	eshold voltage	I _O = 16 mA			-0.2			V
V _{hys}	Hysteresis voltage (VIT-	- VIT_)					45		mV
VIK	Enable input clamp volta	ge	$I_{I} = -18 \text{ mA}$				-0.9	-1.5	V
Vон	High-level output voltage		$V_{ID} = 200 \text{ mV},$	I _{OH} = -8 m/	A	3.5	4.5		V
VOL	Low-level output voltage		$V_{ID} = -200 \text{ mV},$	I _{OL} = 8 mA			0.3	0.5	V
loz	High-impedance-state ou	utput current	$V_O = 0 V \text{ to } V_{CC}$					±20	μΑ
			V _{IH} = 12 V,	V _{CC} = 5 V,	Other inputs at 0 V		0.7	1	mA
ļ.	Due input gurrent	A or D innute	V _{IH} = 12 V,	$V_{CC} = 0 V$	Other inputs at 0 V		0.8	1	mA
''	Bus input current	A or B inputs	$V_{IH} = -7 \text{ V},$	V _{CC} = 5 V,	Other inputs at 0 V		-0.5	-0.8	mA
			$V_{IH} = -7 \text{ V},$	$V_{CC} = 0 V$	Other inputs at 0 V		-0.4	-0.8	mA
lн	High-level enable input c	urrent	V _{IH} = 5 V					±20	μΑ
I _{IL}	Low-level enable input co	urrent	V _{IL} = 0 V					-20	μΑ
los	Short-circuit output curre	nt	VO = 0				-80	-120	mA
la a	Cumply ourrant		Outputs enabled,	I _O = 0,	V _{ID} = 5 V		11	20	mA
CC	ICC Supply current		Outputs disabled				0.9	1.4	IIIA

[†] All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.

switching characteristics, V_{CC} = 5 V, C_L = 15 pF, T_A = 25°C

	PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
tPHL	Propagation delay time, high- to low-level output	$V_{ID} = -1.5 \text{ V to } 1.5 \text{ V},$	11	22	30	ns
tPLH	Propagation delay time, low- to high-level output	See Figure 1	11	22	30	ns
^t PZH	Output enable time to high level	See Figure 2		17	30	ns
tPZL	Output enable time to low level	See Figure 3		18	30	ns
tPHZ	Output disable time from high level	See Figure 2		30	40	ns
t _{PLZ}	Output disable time from low level	See Figure 3		23	30	ns
t _{sk(p)}	Pulse skew (tpHL - tpLH)	See Figure 2		4	6	ns
t _t	Transition time	See Figure 1		3	10	ns

PARAMETER MEASUREMENT INFORMATION

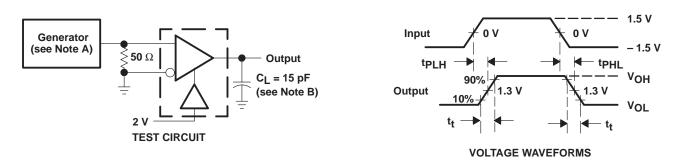
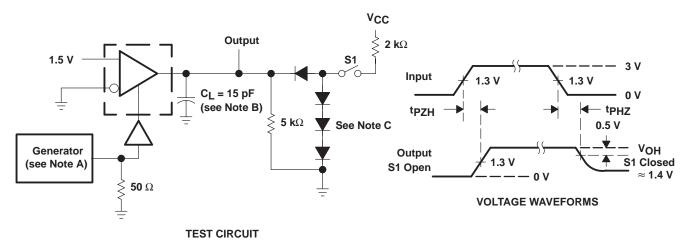


Figure 1. tpLH and tpHL Test Circuit and Voltage Waveforms



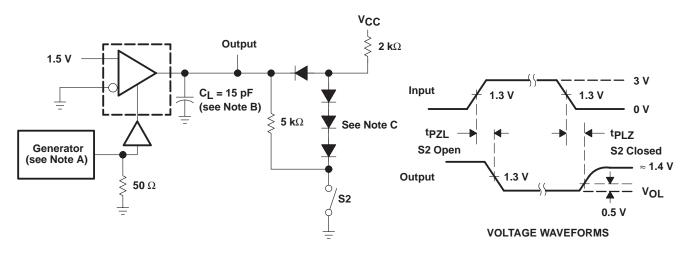
NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_f \le 6$ ns, $Z_O = 50 \ \Omega$.

- B. C_L includes probe and jig capacitance.
- C. All diodes are 1N916 or equivalent.

Figure 2. tpHZ and tpZH Test Circuit and Voltage Waveforms

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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_{\Gamma} \le 6$ ns, $t_f \le 6 \text{ ns}, Z_O = 50 \Omega.$
 - B. C_L includes probe and jig capacitance.
 - C. All diodes are 1N916 or equivalent.

Figure 3. tpzL and tpLZ Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS

5.5

4.5

4

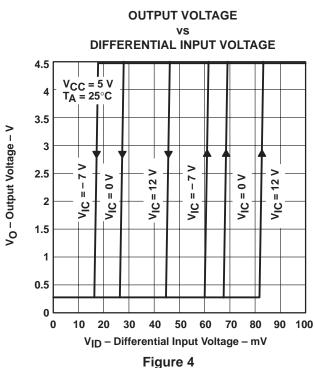
3

2.5

2

3.5

5



V_{OH} - High-Level Output Voltage - V $V_{ID} = 0.2 V$ 0.5 T_A = 25°C 0 -4 -8 -12 -16 -20 -24 -28 -32 -36 -40IOH - High-Level Output Current - mA Figure 5

HIGH-LEVEL OUTPUT VOLTAGE

HIGH-LEVEL OUTPUT CURRENT

 $V_{CC} = 5 V$

V_{CC} = 5.25 V

V_{CC} = 4.75 V



TYPICAL CHARACTERISTICS

LOW-LEVEL OUTPUT VOLTAGE LOW-LEVEL OUTPUT CURRENT 660 T_A = 25°C 600 V_CC = 5 V VoL - Low-Level Output Voltage - mV $V_{ID} = 200 \text{ mV}$ 540 480 420 360 300 240 180 120 60 0 0 12 15 18 21 27 30 IOL - Low-Level Output Current - mA

Figure 6

INPUT CURRENT

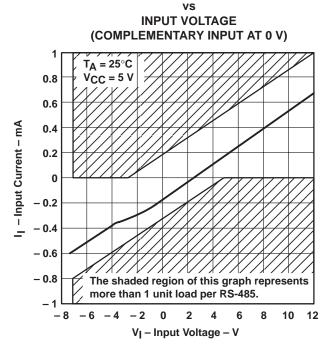
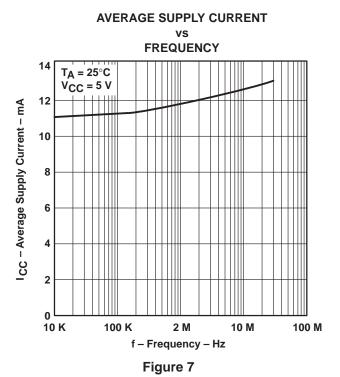


Figure 8



PROPAGATION DELAY TIME
vs
FREE-AIR TEMPERATURE

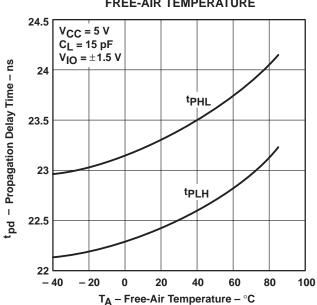


Figure 9

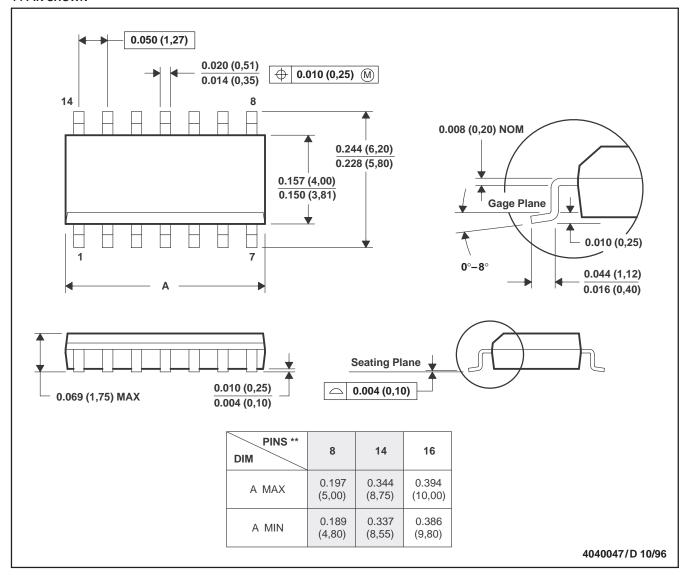
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MECHANICAL DATA

D (R-PDSO-G**)

14 PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012



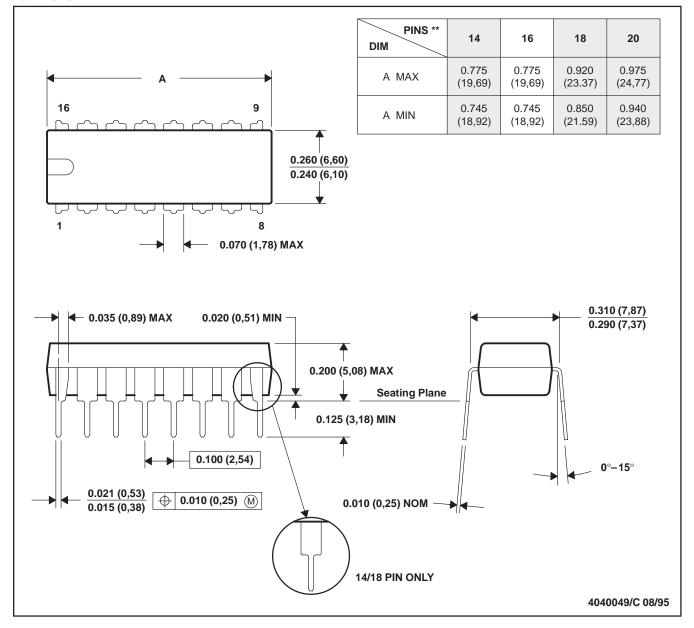
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MECHANICAL DATA

N (R-PDIP-T**)

16 PIN SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-001 (20 pin package is shorter then MS-001.)



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